

**MAPC-A1100** 

Rev. V8

#### **Features**

- MACOM PURE CARBID® Amplifier Series
- Suitable for Linear & Saturated Applications
- · CW & Pulsed Operation: 65 W Output Power
- Internally Pre-Matched
- 28 V and 50 V Operation
- Compatible with MACOM Power Management Bias Controller/Sequencer MABC-11040

# **Applications**

Military Radio Communications, RADAR, Avionics, Digital Cellular Infrastructure, RF Energy, and Test Instrumentation.

# **Description**

The MAPC-A1100 is a high power GaN on Silicon Carbide HEMT D-mode amplifier suitable for DC - 3.5 GHz frequency operation. The device supports both CW and pulsed operation with output power levels of at least 65 W (48.1 dBm) in an air cavity ceramic package.

# **Typical Performance:**

Measured under load-pull at 2.5 dB compression, 100 µs pulse width, 10% duty cycle.

•  $V_{DS} = 50 \text{ V}, I_{DQ} = 110 \text{ mA}, T_{C} = 25^{\circ}\text{C}$ 

Frequency (GHz)	Output Power <sup>1</sup> (dBm)	Gain <sup>2</sup> (dB)	η <sub>D</sub> <sup>2</sup> (%)
0.9	48.7	24.2	73.4
1.4	48.6	20.7	72.4
2.0	48.9	18.4	65.0
2.5	49.3	17.4	68.2
3.0	48.9	16.4	69.7
3.5	48.7	15.8	74.0

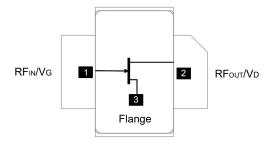
•  $V_{DS} = 28 \text{ V}, I_{DQ} = 110 \text{ mA}, T_{C} = 25^{\circ}\text{C}$ 

Frequency (GHz)	Output Power <sup>1</sup> (dBm)	Gain² (dB)	η <sub>D</sub> <sup>2</sup> (%)
0.9	46.0	20.9	72.7
1.4	45.8	18.6	71.2
2.0	46.6	16.5	67.9
2.5	46.7	15.4	70.7
3.0	46.2	14.2	70.5
3.5	46.0	13.8	74.1

- 1. Load impedance tuned for maximum output power.
- 2. Load impedance tuned for maximum drain efficiency.



#### **Functional Schematic**



# Pin Configuration

Pin#	Pin Name	Function
1	RF <sub>IN</sub> / V <sub>G</sub>	RF Input / Gate
2	RF <sub>OUT</sub> / V <sub>D</sub>	RF Output / Drain
3	Flange <sup>3</sup>	Ground / Source

<sup>3.</sup> The flange on the package bottom must be connected to RF, DC and thermal ground.

# **Ordering Information**

Part Number	Package
MAPC-A1100-AS000	Bulk Quantity: Earless
MAPC-A1100-ASTR1	Tape and Reel: Earless
MAPC-A1100-ASSB1	Sample Board: Earless
MAPC-A1100-AB000	Bulk Quantity: Boltdown
MAPC-A1100-ABTR1	Tape and Reel: Boltdown
MAPC-A1100-ABSB1	Sample Board: Boltdown

<sup>\*</sup> Restrictions on Hazardous Substances, compliant to current RoHS EU directive.

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# RF Electrical Characteristics: $T_C = 25^{\circ}C$ , $V_{DS} = 50 \text{ V}$ , $I_{DQ} = 110 \text{ mA}$ Note: Performance in MACOM Evaluation Test Fixture, 50 $\Omega$ system

Parameter	Test Conditions	Symbol	Min.	Тур.	Max.	Units
Small Signal Gain	Pulsed <sup>4</sup> , 3.5 GHz	Gss	-	17.7	-	dB
Power Gain	Pulsed <sup>4</sup> , 3.5 GHz, 2.5 dB Gain Compression	G <sub>SAT</sub>	-	15.1		dB
Saturated Drain Efficiency	Pulsed <sup>4</sup> , 3.5 GHz, 2.5 dB Gain Compression	η <sub>SAT</sub>	-	70.5	-	%
Saturated Output Power	Pulsed <sup>4</sup> , 3.5 GHz, 2.5 dB Gain Compression	P <sub>SAT</sub>	-	46.2	-	dBm
Gain Variation (-40°C to +85°C)	Pulsed <sup>4</sup> , 3.5 GHz	ΔG	-	0.012	-	dB/°C
Power Variation (-40°C to +85°C)	Pulsed <sup>4</sup> , 3.5 GHz	ΔP2.5dB	-	0.005	-	dB/°C
Power Gain	Pulsed <sup>4</sup> , 3.5 GHz, P <sub>IN</sub> = 30.5 dBm	G <sub>P</sub>	-	15.5	-	dB
Drain Efficiency	Pulsed <sup>4</sup> , 3.5 GHz, P <sub>IN</sub> = 30.5 dBm	η	-	69.5	-	%
Ruggedness: Output Mismatch	All phase angles	Ψ	Ψ VSWR = 10:1, No Damage		age	

# RF Electrical Specifications: $T_A = 25^{\circ}C$ , $V_{DS} = 50 \text{ V}$ , $I_{DQ} = 110 \text{ mA}$ Note: Performance in MACOM Production Test Fixture, $50 \Omega$ system

Parameter	Test Conditions	Symbol	Min.	Тур.	Max.	Units
Power Gain	Pulsed <sup>4</sup> , 3.5 GHz, 2.5 dB Gain Compression	$G_{SAT}$	14.7	15.6	-	dB
Saturated Drain Efficiency	Pulsed <sup>4</sup> , 3.5 GHz, 2.5 dB Gain Compression	η <sub>SAT</sub>	60	65.1	-	%
Saturated Output Power	Pulsed <sup>4</sup> , 3.5 GHz, 2.5 dB Gain Compression	P <sub>SAT</sub>	45.8	47.2	-	dBm
Power Gain	Pulsed <sup>4</sup> , 3.5 GHz, P <sub>IN</sub> = 30.5 dBm	$G_{P}$	15.4	16.3	-	dB
Drain Efficiency	Pulsed <sup>4</sup> , 3.5 GHz, P <sub>IN</sub> = 30.5 dBm	η	58	63.3	-	%

<sup>4.</sup> Pulse details: 100  $\mu s$  pulse width, 10% Duty Cycle.

# DC Electrical Characteristics T<sub>A</sub> = 25°C

Parameter	Test Conditions	Symbol	Min.	Тур.	Max.	Units
Drain-Source Leakage Current	$V_{GS}$ = -8 V, $V_{DS}$ = 130 V	I <sub>DLK</sub>	-	-	6.72	mA
Gate-Source Leakage Current	$V_{GS}$ = -8 V, $V_{DS}$ = 0 V	I <sub>GLK</sub>	-	=	6.72	mA
Gate Threshold Voltage	$V_{DS} = 50 \text{ V}, I_{D} = 6.72 \text{ mA}$	$V_{T}$	-3.6	-3.1	-	V
Gate Quiescent Voltage	V <sub>DS</sub> = 50 V, I <sub>D</sub> = 110 mA	$V_{GSQ}$	-	-2.6	-	V
Maximum Drain Current	$V_{DS}$ = 7 V pulsed, pulse width 300 µs	I <sub>D, MAX</sub>	-	5.7	-	Α



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# Absolute Maximum Ratings 5,6,7,8,9

Parameter	Absolute Maximum
Drain Source Voltage, V <sub>DS</sub>	130 V
Gate Source Voltage, V <sub>GS</sub>	-10 to 3 V
Gate Current, I <sub>G</sub>	6.7 mA
Storage Temperature Range	-65°C to +150°C
Case Operating Temperature Range	-40°C to +85°C
Channel Operating Temperature Range, T <sub>CH</sub>	-40°C to +225°C
Absolute Maximum Channel Temperature	+250°C

- Exceeding any one or combination of these limits may cause permanent damage to this device.
- MACOM does not recommend sustained operation above maximum operating conditions.

- Operating at drain source voltage  $V_{DS} < 55 \text{ V}$  will ensure MTTF > 2 x 10<sup>6</sup> hours.

  Operating at nominal conditions with  $T_{CH} \le 225^{\circ}\text{C}$  will ensure MTTF > 2 x 10<sup>6</sup> hours.

  MTTF may be estimated by the expression MTTF (hours) = A  $e^{\frac{[B+C/(T+273)]}{2}}$  where T is the channel temperature in degrees Celsius, A = 1, B = -38.215, and C = 26,343.

# Thermal Characteristics<sup>10</sup>

Parameter	Test Conditions	Symbol	Typical	Units
Thermal Resistance using Finite Element Analysis	$V_{DS} = 50 \text{ V},$ $T_{C} = 85^{\circ}\text{C}, T_{CH} = 225^{\circ}\text{C}$	$R_{\theta}(FEA)$	4.63	°C/W
Thermal Resistance using Infrared Measurement of Die Surface Temperature	V <sub>DS</sub> = 50 V, T <sub>C</sub> = 85°C, T <sub>CH</sub> = 225°C	$R_{\theta}(IR)$	3.70	°C/W

<sup>10.</sup> Case temperature measured using thermocouple embedded in heat-sink. Contact local applications support team for more details on this measurement

#### **Handling Procedures**

Please observe the following precautions to avoid damage:

#### Static Sensitivity

Gallium Nitride Circuits are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these devices.



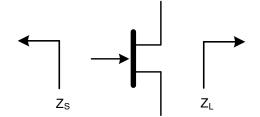
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# 50 V Pulsed<sup>4</sup> Load-Pull Performance: Reference Plane at Device Leads

		Maximum Output Power							
			$V_{DS} = 50 \text{ V}, I_{DQ} = 110 \text{ mA}, T_C = 25^{\circ}\text{C}, P2.5 \text{dB}$						
Frequency (GHz)	Z <sub>source</sub> (Ω)	Z <sub>LOAD</sub> <sup>11</sup> (Ω)	Gain (dB)	P <sub>OUT</sub> (dBm)	P <sub>OUT</sub> (W)	η <sub>D</sub> (%)	AM/PM (°)		
0.9	1.3 + j2.0	12.6 + j3.1	22.5	48.7	74.6	65.0	64.9		
1.4	1.3 - j2.4	10.3 + j2.7	19.6	48.6	72.9	67.1	45.7		
2.0	1.9 - j6.7	8.0 + j1.9	16.7	48.9	77.3	56.0	28.2		
2.5	2.9 - j12.7	7.9 + j0.5	15.8	49.3	84.1	60.2	10.5		
2.7	4.2 - j15.6	7.7 - j0.2	15.6	48.8	76.3	62.6	0.4		
3.0	9.8 - j20.6	6.6 - j1.2	14.3	48.9	77.5	61.3	-18.5		
3.5	28.3 - j0.5	5.5 - j3.0	14.2	48.7	73.9	63.8	-75.7		

		Maximum Drain Efficiency							
			$V_{DS} = 50 \text{ V}, I_{DQ} = 110 \text{ mA}, T_{C} = 25^{\circ}\text{C}, P2.5dB}$						
Frequency (GHz)	Z <sub>source</sub> (Ω)	Z <sub>LOAD</sub> <sup>12</sup> (Ω)	Gain (dB)	P <sub>OUT</sub> (dBm)	P <sub>OUT</sub> (W)	η₀ (%)	AM/PM (°)		
0.9	0.7 + j1.2	17.6 + j12.6	24.2	47.3	54.2	73.4	54.1		
1.4	1.1 - j2.8	10.1 + j10.0	20.7	47.5	56.6	72.4	33.4		
2.0	1.7 - j7.4	6.9 + j7.3	18.4	47.8	60.9	65.0	16.5		
2.5	2.8 - j13.5	6.1 + j4.5	17.4	47.9	61.0	68.2	-0.8		
2.7	3.9 - j16.4	5.4 + j3.5	17.1	47.5	56.3	67.9	-8.8		
3.0	10.4 - j25.4	4.3 + j2.2	16.4	47.8	59.9	69.7	-30.4		
3.5	28.9 + j10.4	3.1 - j0.4	15.8	46.7	46.7	74.0	-81.4		

#### Impedance Reference



 $Z_{\text{SOURCE}}$  = Measured impedance presented to the input of the device at package reference plane.  $Z_{\text{LOAD}}$  = Measured impedance presented to the output of the

- 11. Load Impedance for optimum output power.
- 12. Load Impedance for optimum efficiency.

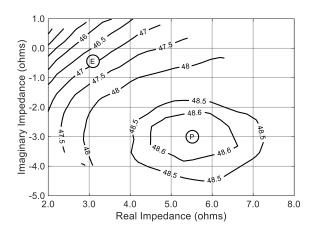
device at package reference plane.



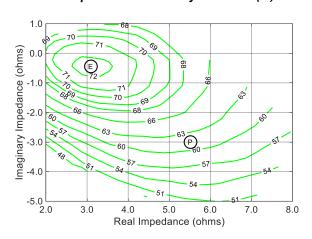
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# Pulsed<sup>4</sup> Load-Pull Performance @ 3.5 GHz

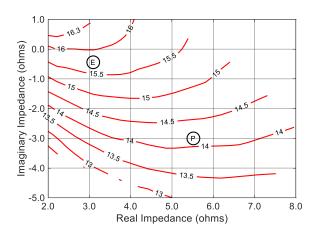
#### P2.5dB Loadpull Output Power Contours (dBm)



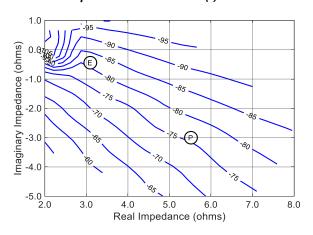
#### P2.5dB Loadpull Drain Efficiency Contours (%)



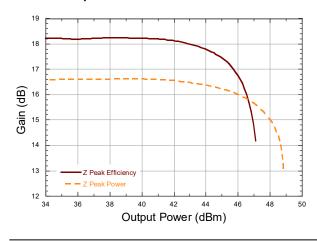
#### P2.5dB Loadpull Gain Contours (dB)



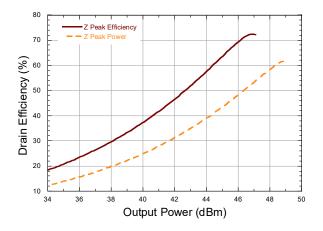
P2.5dB Loadpull AM/PM Contours (°)



#### Gain vs. Output Power



Drain Efficiency vs. Output Power





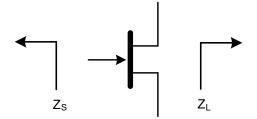
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# 28 V Pulsed<sup>4</sup> Load-Pull Performance: Reference Plane at Device Leads

		Maximum Output Power							
			V <sub>DS</sub> = 28 V, I <sub>DQ</sub> = 110 mA, T <sub>C</sub> = 25°C, P2.5dB						
Frequency (GHz)	Z <sub>SOURCE</sub> (Ω)	Z <sub>LOAD</sub> <sup>11</sup> (Ω)	Gain (dB)	P <sub>OUT</sub> (dBm)	P <sub>OUT</sub> (W)	η <sub>□</sub> (%)	AM/PM (°)		
0.9	1.4 + j2.0	8.1 - j0.7	19.8	46.0	39.4	58.0	71.0		
1.4	1.6 - j2.5	7.2 - j1.3	17.0	45.8	37.6	61.5	54.4		
2.0	2.0 - j7.0	7.0 - j1.7	15.1	46.6	45.9	64.1	35.2		
2.5	3.4 - j13.4	6.9 - j3.4	13.6	46.7	46.5	60.1	15.4		
2.7	4.4 - j15.9	6.3 - j4.3	13.1	46.0	40.0	57.3	8.8		
3.0	11.3 - j22.6	6.1 - j4.9	13.1	46.2	41.8	63.5	-13.9		
3.5	28.3 + j4.4	5.3 - j6.5	12.1	46.0	39.7	62.6	-75.3		

		Maximum Drain Efficiency $V_{DS} = 28 \text{ V, } I_{DQ} = 110 \text{ mA, } T_{C} = 25^{\circ}\text{C, } P2.5 \text{dB}$						
Frequency (GHz)	Z <sub>source</sub> (Ω)	Z <sub>LOAD</sub> <sup>12</sup> (Ω)	Gain (dB)	P <sub>OUT</sub> (dBm)	P <sub>OUT</sub> (W)	η <sub>□</sub> (%)	AM/PM (°)	
0.9	0.8 + j1.2	13.3 + j9.4	20.9	43.0	20.8	72.7	55.1	
1.4	1.1 - j3.3	9.4 + j6.8	18.6	43.6	22.7	71.2	36.5	
2.0	1.8 - j7.6	6.5 + j2.9	16.5	45.1	32.5	67.9	22.2	
2.5	3.2 - j14.1	5.7 + j1.4	15.4	45.1	32.0	70.7	-2.8	
2.7	4.3 - j17.6	5.3 + j0.1	14.8	44.7	29.3	66.7	-6.4	
3.0	13.0 - j26.4	4.8 - j0.9	14.2	44.7	29.7	70.5	-30.7	
3.5	24.7 + j12.6	3.3 - j3.1	13.8	44.0	25.1	74.1	-98.5	

#### Impedance Reference



Z<sub>SOURCE</sub> = Measured impedance presented to the input of the device at package reference plane.  $Z_{\text{LOAD}}$  = Measured impedance presented to the output of the

- 11. Load Impedance for optimum output power.
- 12. Load Impedance for optimum efficiency.

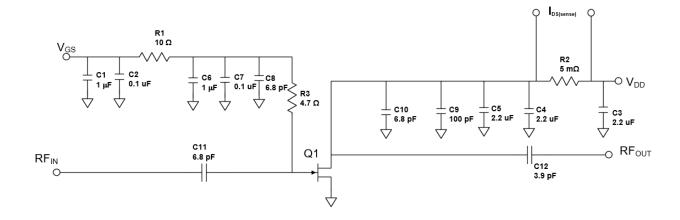
device at package reference plane.



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# **Evaluation Test Fixture and Recommended Tuning Solution 3.45 - 3.55 GHz**



#### **Description**

Parts measured on evaluation board (20-mil thick RO4350). Matching is provided using a combination of lumped elements and transmission lines as shown in the simplified schematic above. Recommended tuning solution component placement, transmission lines, and details are shown on the next page.

# Bias Sequencing Turning the device ON

- 1. Set V<sub>GS</sub> to pinch-off (V<sub>P</sub>).
- 2. Turn on V<sub>DS</sub> to nominal voltage (50 V).
- 3. Increase  $V_{\text{GS}}$  until  $I_{\text{DS}}$  current is reached.
- 4. Apply RF power to desired level.

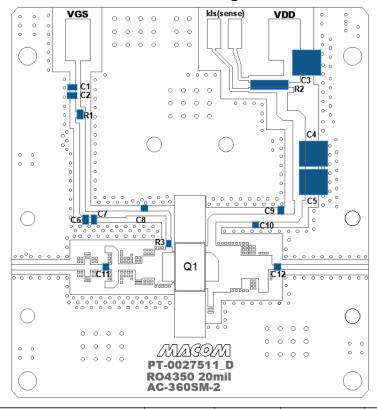
### **Turning the device OFF**

- 1. Turn the RF power OFF.
- 2. Decrease  $V_{GS}$  down to  $V_P$  pinch-off.
- 3. Decrease  $V_{DS}$  down to 0 V.
- 4. Turn off V<sub>GS</sub>.



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# **Evaluation Test Fixture and Recommended Tuning Solution 3.45 - 3.55 GHz**



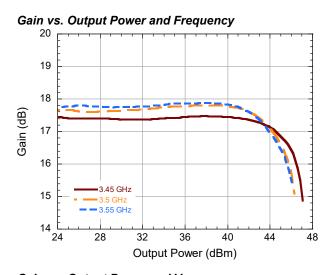
Reference Designator	Value	Tolerance	Manufacturer	Part Number	
C1, C6	1 μF	+/- 10 %	Murata	GRM21BC72A105KE01L	
C2, C7	0.1 μF	+/- 10 %	Murata	GCD21BR72A104KA01L	
C3, C4, C5	2.2 μF	+/- 20 %	Murata	KRM55TR72E225MH01L	
C8, C10, C11	6.8 pF	+/- 0.1pF	PPI	0603N6R8BW251	
C9	100 pF	+/- 5 %	Murata	GQM2195C2E101JB12	
C12	3.9 pF	+/- 0.25 pF	PPI	0505C3R9CW151X	
R1	10 Ω	+/- 1%	Vishay Dale	CRCW080510R0FKTA	
R2	5 mΩ	+/- 1%	Susumu	RL7520WT-R005-F	
R3	4.7 Ω	+/- 0.1%	Stackpole Elec- tronics Inc	RNCF0603BKE4R70	
Q1	MACOM GaN Power Amplifier			MAPC-A1100	
PCB	RO4350, 20 mil, 1 oz. Cu, Au Finish				

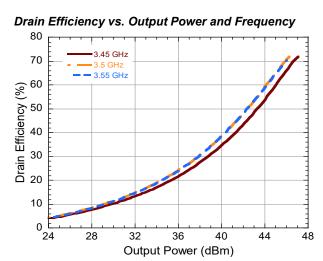


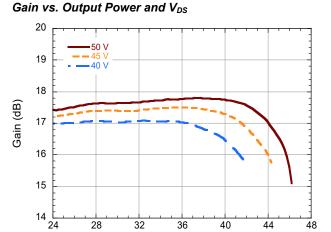
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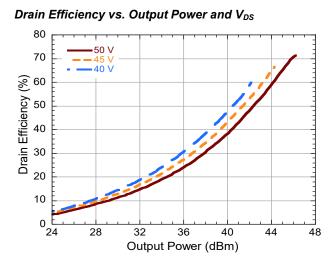
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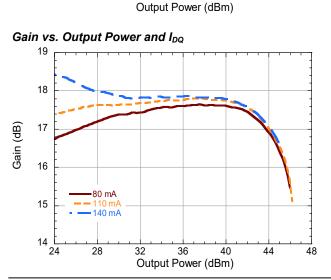
Typical Performance Curves as Measured in the 3.45 - 3.55 GHz Evaluation Test Fixture: Pulsed<sup>4</sup> 3.5 GHz,  $V_{DS}$  = 50 V,  $I_{DQ}$  = 110 mA,  $T_{C}$  = 25°C (Unless Otherwise Noted)

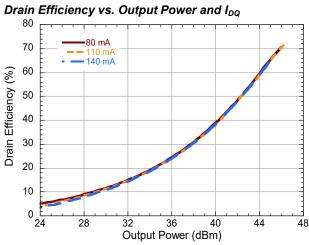












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Typical Performance Curves as Measured in the 3.45 - 3.55 GHz Evaluation Test Fixture: Pulsed<sup>4</sup> 3.5 GHz,  $V_{DS}$  = 50 V,  $I_{DQ}$  = 110 mA,  $T_{C}$  = 25°C (Unless Otherwise Noted)

Gain vs. Output Power and T<sub>C</sub>

20

19

18

17

16

15

-40°C

-25°C

-85°C

14

24

28

32

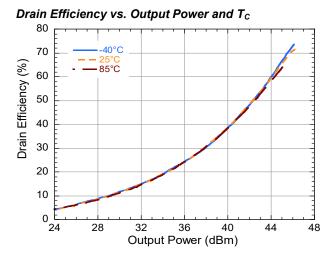
36

40

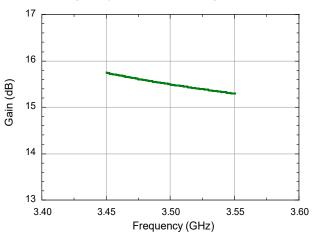
44

48

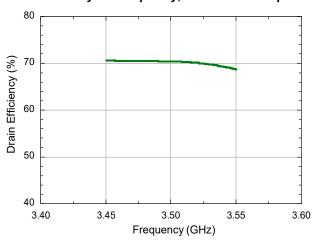
Output Power (dBm)



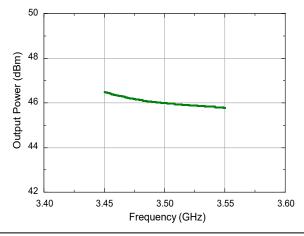
Gain vs. Frequency, 2.5dB Gain Compression



Drain Efficiency vs. Frequency, 2.5dB Gain Compression



#### Output Power vs. Frequency, 2.5dB Gain Compression

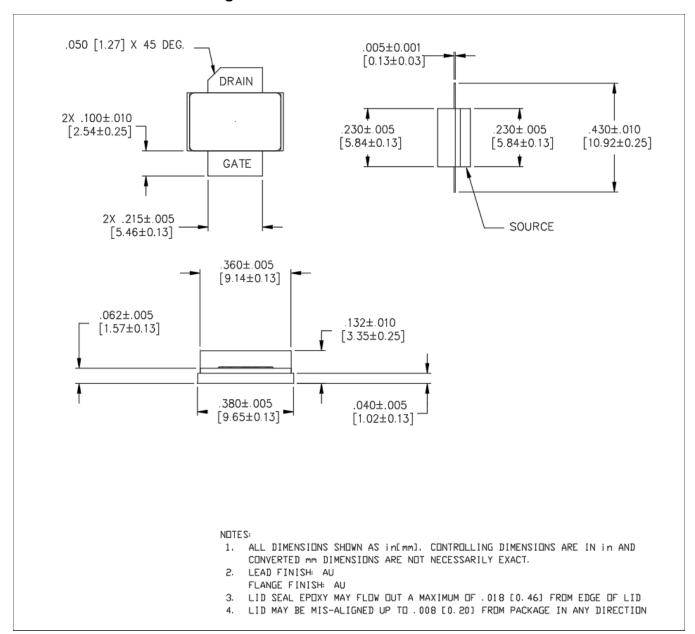




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# Lead-Free AC-360S-2 Package Dimensions<sup>†</sup>



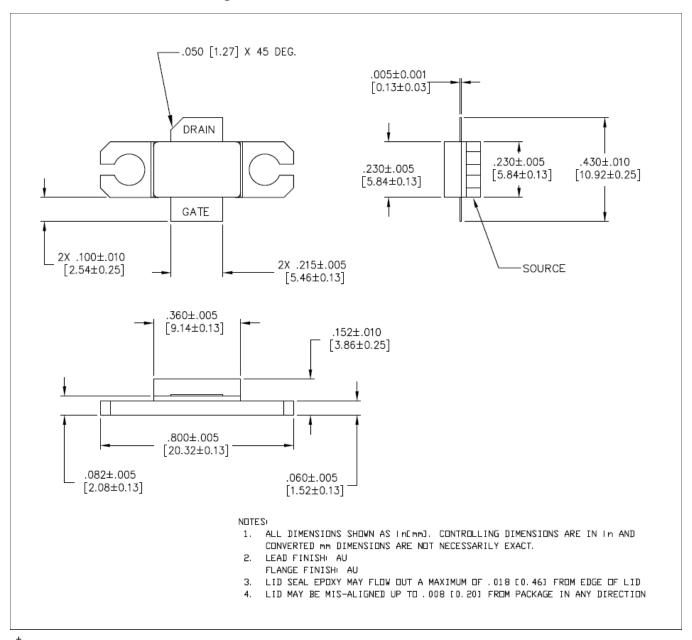
<sup>&</sup>lt;sup>†</sup> Reference Application Note AN0004363 for lead-free solder reflow recommendations. Meets JEDEC moisture sensitivity level 3 requirements. Plating is Au.



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# Lead-Free AC-360B-2 Package Dimensions<sup>†</sup>



<sup>&</sup>lt;sup>†</sup> Reference Application Note AN0004363 for lead-free solder reflow recommendations. Meets JEDEC moisture sensitivity level 3 requirements. Plating is Au.

# GaN Amplifier 50 V, 65 W DC - 3.5 GHz



# MACOM PURE CARBIDE

**MAPC-A1100** 

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